#### Searching for Dark Matter in the Alps with DAMIC-M Sravan Munagavalasa DAMIC-M Collaboration







#### DAMIC-M **DArk MAtter In CCDs at Modane**

Dark Matter Charge-Coupled Devices Modane, France



Laboratoire Souterrain de Modane (LSM)



# DM





12 868 m

#### **DAMIC-M DAMIC-M In a Nutshell**

- 1 kg-year of Target Exposure
- background rate of ~0.1 dru
- detect nuclear and electron recoils to search for light dark matter candidates
- scheduled for installation at LSM end of 2024

1 dru [differential rate unit] = 1 background event/keV/kg/day







#### **DAMIC-M Background Mitigation**

18-ton shielding in shipping container to transport wafers from Europe to Canada (and back as CCDs)



• Copper: Electroform copper machined underground **MAJORANA** copper at SURF Shipped to LSM in shielded container



• Silicon: cosmic rays exposure < 2 months to achieve background goal. We have implemented strict shielding protocols for all transports/storage of silicon



Europe -> Canada -> California -> Canada -> Washington->Modane



#### **DAMIC-M Dark Matter Candidates**







## Charge-Coupled Device Operation

- Expose
- Vertical shift down one pixel
  - Horizontal shift one pixel
    - Readout pixel

**Conventional Readout Limitation:** 

 $\sigma_{rms} \approx 3 e^{-1}$ 





#### **Charge-Coupled Device Skipper Readout Stage**

- Implement a floating readout stage
- Allows for Non-Destructive Charge Measurements (NDCM)
- Reduce Statistical Noise by











#### **Charge-Coupled Device Sub-Electron Noise Resolution**





#### DANIC-M Projected Sensitivity

- Design: Low Background
- Silicon: Low Ionization Threshold
- Skipper: Low Readout Noise









#### Low Background Chamber Main Objectives

- CCD test in low background environment
- Validation of DAMIC-M readout electronics
- Test bench for data collection strategies









#### Low Background Chamber (LBC) Main Objectives

- CCD test in low background environment
- Validation of DAMIC-M readout electronics
- Test bench for data collection strategies
- Science Runs





#### Low Background Chamber **First Science Run**

- 85.2 gram-days total (after masking)
- Background rate 12.5 dru
- Resolution 0.2e-
- Dark current 4.5E-3 e-/ pixel/day



#### Partial CCD image











#### **DM-e Scattering Analysis** Log Likelihood minimization





$$\overline{\sigma}_{g}=2 \times 10^{37} \text{ cm}^{2}$$

$$\sigma_{res}) = \sum_{i=0}^{N_{pix}} N_{im} \sum_{n_{q}=0}^{\infty} \left[ \sum_{j=0}^{n_{q}} S(j|m_{\chi}, \bar{\sigma}_{e}, e_{i}) \text{Pois}(n_{q} - j|\lambda_{i} - \lambda_{S,i}) \right] \text{Gaus}(p|n_{\chi}, \bar{\sigma}_{e}, e_{i}) \text{Pois}(n_{q} - j|\lambda_{i} - \lambda_{S,i}) = \frac{1}{4} \sum_{j=0}^{1} \frac{1}{4} \sum_{j=0}^{n_{q}} \frac{1}{4$$



Editors' Suggestion

#### **DM-e Scattering Analysis**



![](_page_14_Figure_5.jpeg)

### Search for Daily Modulations

![](_page_15_Figure_2.jpeg)

![](_page_15_Picture_3.jpeg)

![](_page_15_Figure_4.jpeg)

## Future of LBC

- Installation of new CCD Modules
- Installation Installation of low noise **DAMIC-M** electronics with custom design and Firmware
- We continue to commission CCDs to reduce the readout noise and dark current
- We have achieved a background rate of 6.7 dru

New Paper on LBC prepared for JINST arXiv:2407.17872

![](_page_16_Picture_6.jpeg)

![](_page_16_Picture_7.jpeg)

![](_page_16_Picture_8.jpeg)

![](_page_16_Picture_9.jpeg)

![](_page_16_Picture_10.jpeg)

![](_page_16_Picture_11.jpeg)

![](_page_16_Picture_12.jpeg)

#### **Progress on DAMIC-M** University of Washington, Seattle

- CCDs shipped from SNOLAB to UW for wirebonding to CCD Pitch Adapter for DAMIC-M
- Stored Underground at UW with custom Nitrogen gas plumbing

![](_page_17_Picture_3.jpeg)

![](_page_17_Picture_4.jpeg)

![](_page_17_Picture_5.jpeg)

#### **Commissioning of CCDs for DAMIC-M** University of Washington, Seattle

- 2 separate test chambers have been commissioned at UW for the testing and characterization
- Only CCDs that pass our criteria will be used in DAMIC-M

![](_page_18_Picture_3.jpeg)

![](_page_18_Picture_4.jpeg)

#### Installation of DAMIC-M by the end of the year

![](_page_19_Picture_1.jpeg)

![](_page_19_Picture_2.jpeg)

![](_page_19_Picture_3.jpeg)

#### **The DAMIC-M Collaboration**

![](_page_20_Picture_1.jpeg)

![](_page_20_Picture_2.jpeg)

![](_page_20_Picture_3.jpeg)